

Case No. 3591-1154

## **DECLARATION FOR PATENT APPLICATION**

As a below name PADE for, I hereby declare that:

My residence, p	ost office address and citi	zenship are as stated below next to my na	me.		
plural names are		e inventor (if only one name is listed belo ject matter which is claimed and for which			
	is attached hereto.				
was filed on August 27, 2001 as Application Serial No. 09/941,157.					
	and was amended on (if applicable).				
		understand the contents of the above-ider	ntified specification,	including the claims, as	
I acknowledge ( Regulations, § 1		mation which is material to the patentab	ility as defined in T	itle 37, Code of Federal	
inventor's certif United States, li	icate or § 365(a) of any sted below and have also	under 35 U.S.C. § 119(a)-(d) or § 365(b) PCT International application which desidentified below, by checking the box, as on having a filing date before that of the approximately the second s	signated at least one ny foreign applicatio	e country other than the n for patent or inventor's	
Prior Foreign Application(s)				Priority Claimed	
(Number)	) (Country	y) (Day/Month/Year	Filed)	Yes No	
I hereby claim th	ne benefit under 35 U.S.C	C. § 119(e) of any United States provisiona	•	l helow:	
	0/229,210	August 31, 2000	ppou(b)btoc		
(Application Serial No.)		(Filing Date)	<del>_</del>		
application designs is not disclosed U.S.C. § 112, I	gnating the United States, in the prior United States acknowledge the duty to	S.C. § 120 of any United States application listed below and, insofar as the subject mass or PCT International application in the residual disclose information which is material tag date of the prior application and the national states of the prior application and the national states are supplied to the prior application and the national states are supplied to the prior application and the national states applied to the prior application and the national states applied to the prior application and the national states application application and the national states application application application application application applications application and the national states application application application applications application applications applicatio	natter of each of the omanner provided by to patentability as de	claims of this application the first paragraph of 35 efined in 37 CFR § 1.56	
(Applica	ation Serial No.)	(Filing Date)	(Status-patente	d, pending, abandoned)	
belief are believ the like so made that such willful Inventor's Signa	ed to be true; and further are punishable by fine o false statements may jeop ture	herein of my own knowledge are true and that these statements were made with the rimprisonment, or both, under Section 10 pardize the validity of the application or ar	knowledge that wil 001 of Title 18 of the	Iful false statements and United States Code and	
Full name of sole or first inventor		Eric Ping Pang Chan			
Residence		New York, New York, USA			
Citizenship		United States of America			
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Case No. 3591-1154 11.16.01 Inventor's Signature Rama Chorpash Full name of second joint inventor, if any New York, New York Residence Citizenship Post Office Address homas W Inventor's Signature Thomas William Granzow Full name of third joint inventor Byron Center, Michigan Residence US. Citizenship 49315 Post Office Address Inventor's Signature Date: Andrew J. Kurtasch Full name of fourth joint inventor Saugatuck, Michigan Residence 4.50 Citizenship ALLEGAN Post Office Address Date: Inventor's Signature Jeffrey Fredrick Miller Full name of fifth joint inventor New York, New York Residence Citizenship Post Office Address